

Nomination Committee in Hexatronic appointed

In accordance with the principles for appointing the Nomination Committee adopted by the 2025 Annual General Meeting, the Nomination Committee for the Hexatronic Group's 2027 Annual General Meeting has been appointed. According to these principles, the company shall have a nomination committee consisting of members appointed by each of the four largest shareholders in terms of voting rights as of the last day of August. The Chairman of the Board shall be co-opted to the Nomination Committee.

The Nomination Committee has now been appointed and consists of the following members:

- Staffan Ringvall, Handelsbanken Fonder (Chairman of the Nomination Committee)
- Jonas Nordlund, appointed by himself
- Mark Shay, Accendo Capital
- Peter Lundkvist, AP3
- Magnus Nicolin, co-opted, Chairman of the Board of Hexatronic Group

The Nomination Committee represents approximately 18 percent of the outstanding votes in the company. The Nomination Committee's proposals will be presented in the notice to the 2027 Annual General Meeting and on Hexatronic's website.

The Annual General Meeting will be held on May 4, 2027, in Gothenburg.

Shareholders who wish to submit proposals to the Nomination Committee for the 2027 Annual General Meeting may do so by sending an email to linn.lundstedt@hexatronic.com (marked "To the Nomination Committee"). For the Nomination Committee to be able to process proposals in a constructive manner, they should be received no later than January 15, 2027.

For more information, please contact:

Patrik Johannesson, Head of Investor Relations
patrik.johannesson@hexatronic.com
+46 73-033 25 18

About Us

Connectivity creates opportunity. Hexatronic delivers future-ready fiber solutions for critical infrastructure, from telecom networks to rugged environments and data centers. Our systems are built to last, designed to scale, and supported by expert training and field services. In close collaboration with our customers, we shape solutions that strengthen communities and drive innovation in a connected world.